

SUPPLEMENTARY INFORMATION

Cost-Effective Fabrication of Submicron-Scale Patterns Enabled by Microcontact Printing with a Pre-Strained Soft Elastomeric Stamp

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Supplementary Information includes:

Figure S1. An optical image of replicated patterns indicating the loss of the pattern with the adhesive promoter.

Figure S2. A tensile stress versus strain curve of an Ecoflex elastomeric stamp.

Figure S3. Optical microscope images of the PR pattern on the master mold with a periodic line pattern

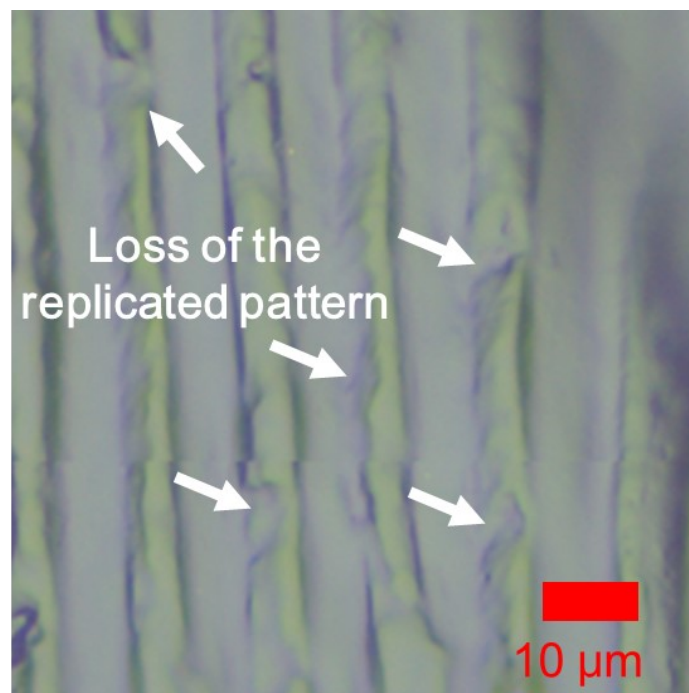


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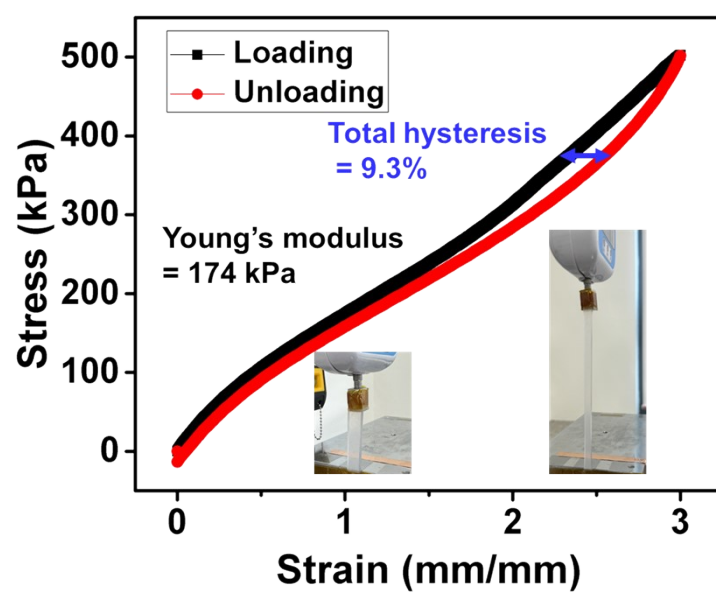


Figure S2. A tensile stress versus strain curve of an Ecoflex elastomeric stamp.

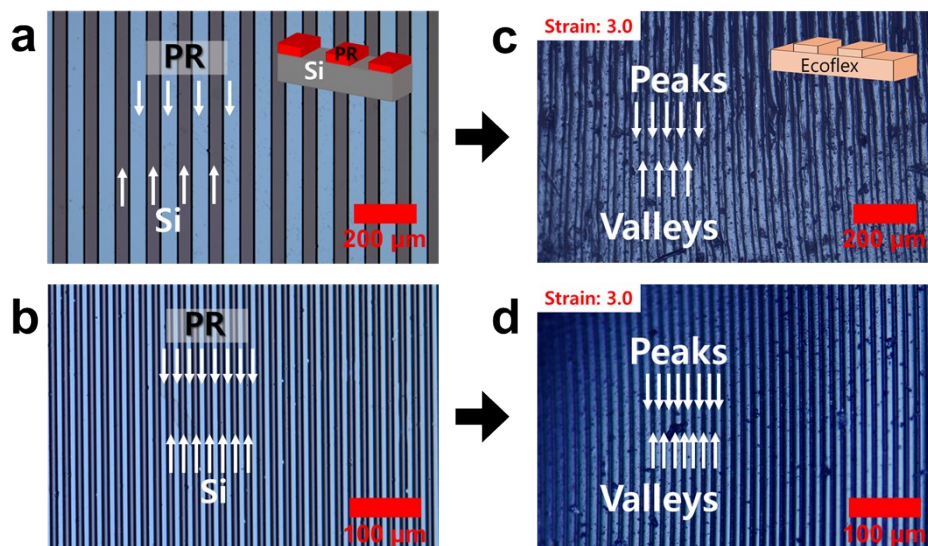


Figure S3. Optical microscope images of the PR pattern on the master mold with a periodic line pattern with width and gap of (a) 50 μm and (b) 10 μm , respectively. Optical microscope images of the replicated mold after pre-stretching and subsequent release, showing a reduction of 60% in dimensions of (c) 20- μm and (d) 4- μm periodic line pattern, respectively.